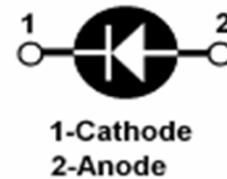
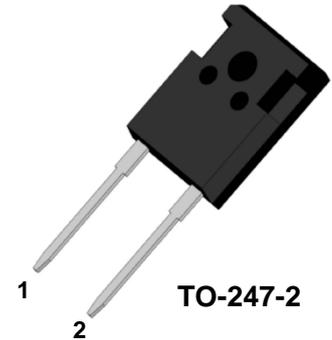


## PRODUCT FEATURES

- Ultrafast Recovery Time
- Low Recovery Loss
- Soft Reverse Recovery Characteristics
- Low Leakage Current
- Low Forward Voltage
- High Surge Current Capability

## APPLICATIONS

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS



## DESCRIPTION

FRED from MacMic utilizes advanced processing techniques to achieve ultrafast recovery times and higher forward current. Its soft recovery characteristics and high reliability suit for wide industrial applications.

## ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol       | Parameter/Test Conditions            |   | Values      | Unit                      |
|--------------|--------------------------------------|---|-------------|---------------------------|
| $V_R$        | Maximum D.C. Reverse Voltage         |   | 600         | V                         |
| $V_{RRM}$    | Maximum Repetitive Reverse Voltage   |   |             |                           |
| $I_{F(AV)}$  | Average Forward Current              | $T_C=110^\circ\text{C}$   | 30          | A                         |
| $I_{F(RMS)}$ | RMS Forward Current                  | $T_C=110^\circ\text{C}$   | 42          |                           |
| $I_{FSM}$    | Non Repetitive Surge Forward Current | $T_J=25^\circ\text{C}, t=10\text{ms}, 50\text{Hz}, \text{Sine}$ | 300         |                           |
| $P_D$        | Power Dissipation                    |   | 156         | W                         |
| $T_J$        | Junction Temperature                 |   | -55 to +150 | $^\circ\text{C}$          |
| $T_{STG}$    | Storage Temperature Range            |   | -55 to +125 | $^\circ\text{C}$          |
| Torque       | To Heat Sink                         | Recommended (M3)  | 1.1         | Nm                        |
| $R_{thJC}$   | Junction to Case Thermal Resistance  |   | 0.8         | $^\circ\text{C}/\text{W}$ |
| Weight       |                                      |   | 6           | g                         |

## ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol   | Parameter/Test Conditions   |  | Min. | Typ. | Max. | Unit          |
|----------|---|--|------|------|------|---------------|
| $I_{RM}$ | Maximum Reverse Leakage Current   | $V_R = 600\text{V}$                          |      |      | 15   | $\mu\text{A}$ |
|          |   | $V_R = 600\text{V}, T_J = 125^\circ\text{C}$ |      |      | 250  | $\mu\text{A}$ |
| $V_F$    | Forward Voltage   | $I_F=30\text{A}$                             |      | 1.5  | 1.8  | V             |
|          |   | $I_F=30\text{A}, T_J=125^\circ\text{C}$      |      | 1.3  |      |               |
| $t_{rr}$ | Reverse Recovery Time ( $I_F = 1\text{A}, di_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$ ) |  |      | 22   | 27   | ns            |
| $t_{rr}$ | Reverse Recovery Time ( $I_F = 0.5\text{A}, I_R=1\text{A}, I_{RR} = 0.25\text{A}$ )               |  |      | 35   | 45   | ns            |

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**ELECTRICAL CHARACTERISTICS** ( $T_C=25^{\circ}\text{C}$  unless otherwise specified)

| Symbol    | Parameter/Test Conditions        | Min. | Typ. | Max. | Unit |
|-----------|----------------------------------|------|------|------|------|
| $t_{rr}$  | Reverse Recovery Time            |      | 70   |      | ns   |
| $I_{RRM}$ | Maximum Reverse Recovery Current |      | 4    |      | A    |
| $Q_{RR}$  | Reverse Recovery Charge          |      | 210  |      | nC   |
| $t_{rr}$  | Reverse Recovery Time            |      | 156  |      | ns   |
| $I_{RRM}$ | Maximum Reverse Recovery Current |      | 8.5  |      | A    |
| $Q_{RR}$  | Reverse Recovery Charge          |      | 720  |      | nC   |

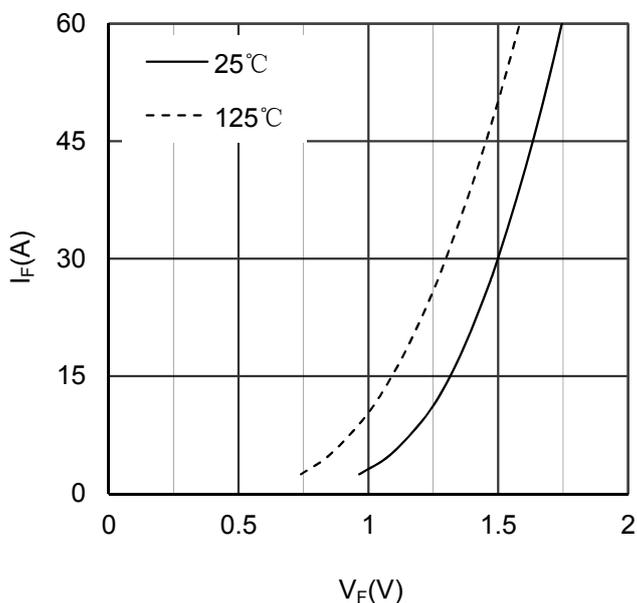


Figure 1. Forward Voltage Drop vs Forward Current

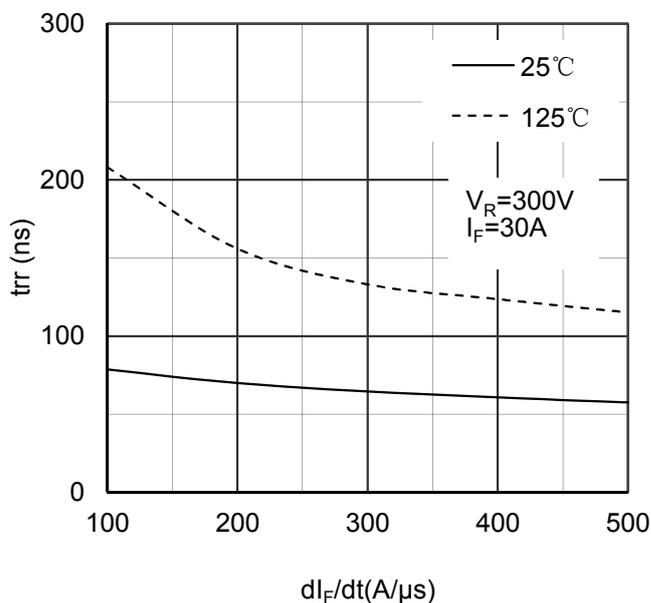


Figure 2. Reverse Recovery Time vs  $dI_F/dt$

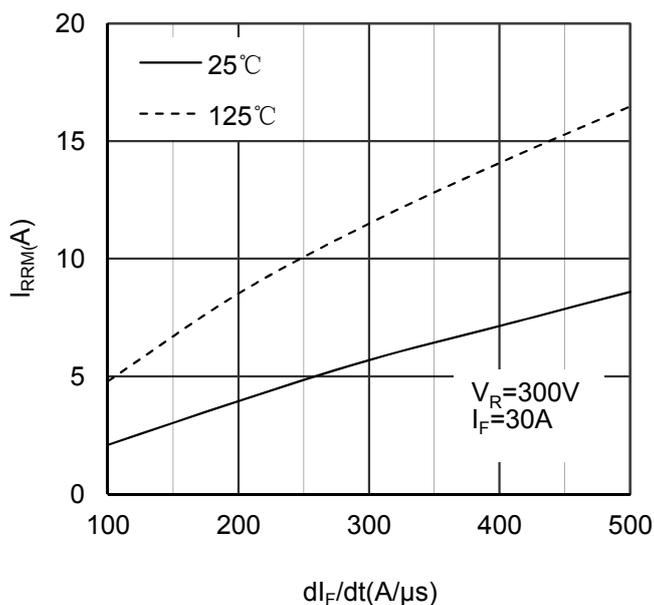


Figure 3. Reverse Recovery Current vs  $dI_F/dt$

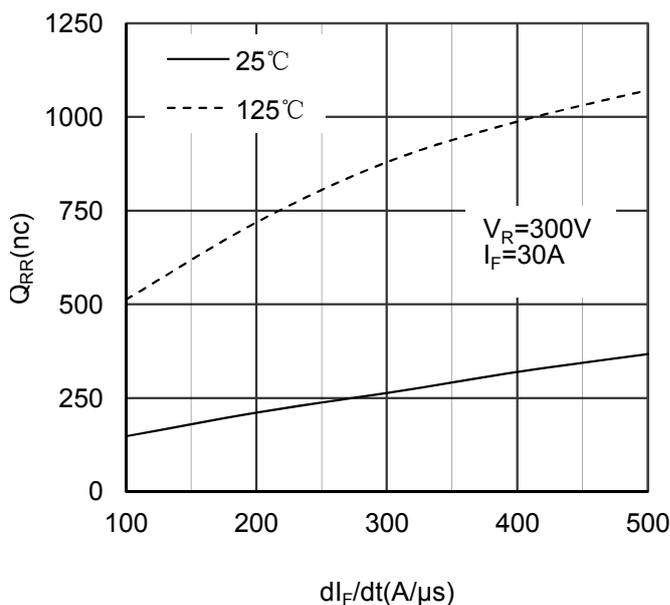


Figure 4. Reverse Recovery Charge vs  $dI_F/dt$

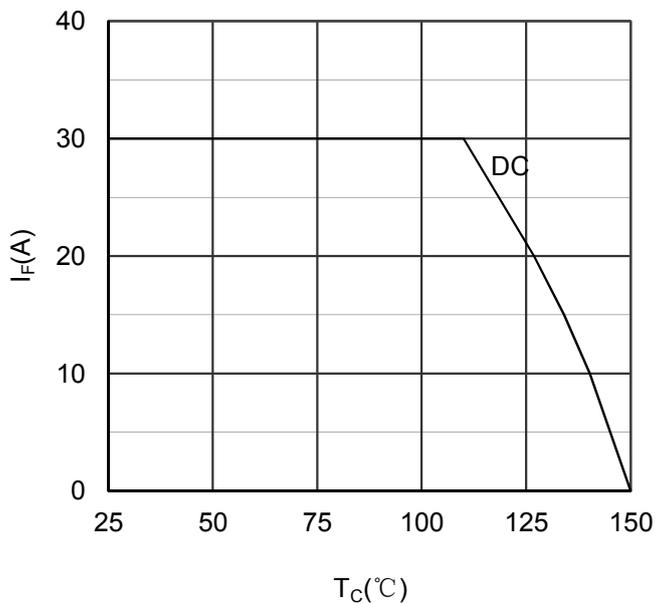


Figure 5. Forward current vs Case temperature

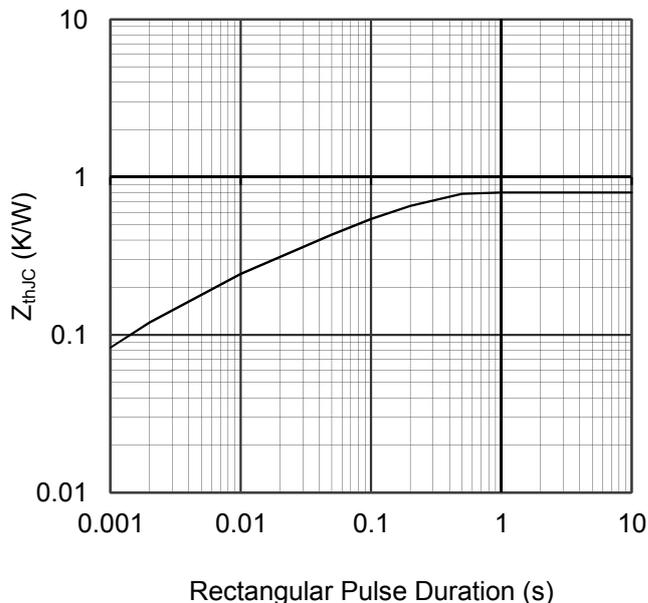


Figure 6. Transient Thermal Impedance

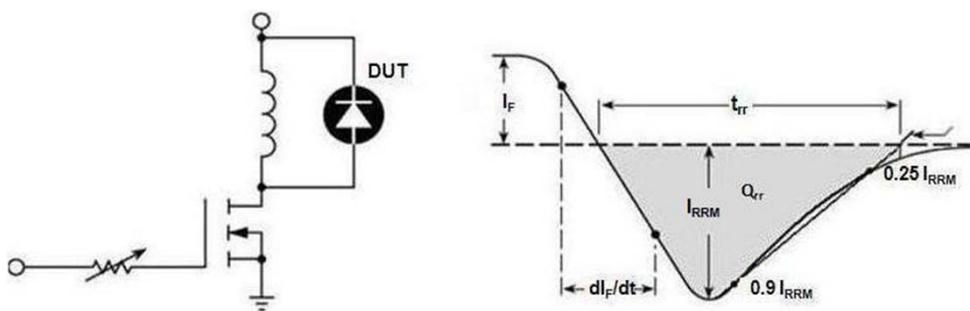
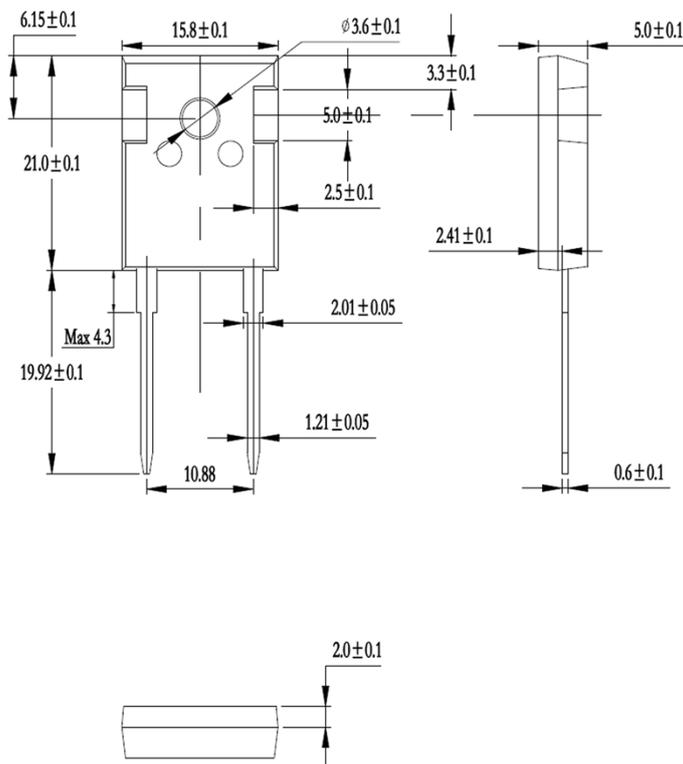


Figure 7. Diode Reverse Recovery Test Circuit and Waveform



Dimensions in (mm)  
Figure 8. Package Outline